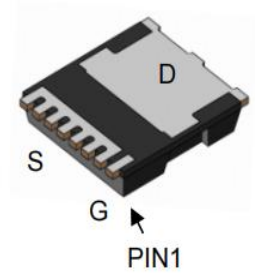




1. Features

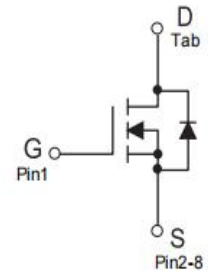
- V_{DS} 150V
- I_D (at $V_{GS}=10V$) 240A
- $R_{DS(ON)}$ (at $V_{GS}=10V$) 3.4m Ω (Typ)

TOLL



2. Mechanical Data

- Case:Molded Plastic,TOLL .
- Epoxy:UL 94V-0 rate flame retardant
- Terminals:Plated Leads Solderable perMIL-STD-750,Method-2026.
- Marking:XNTL1504
- Mounting Position : Any.



3. Maximum Ratings and Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified.

Parameter		Symbol	Value	UNIT
Drain-Source Voltage		V_{DS}	150	V
Gate-Source Voltage		V_{GS}	± 20	V
Continuous Drain Current	$T_C = 25^\circ C$	I_D	240	A
	$T_C = 100^\circ C$		162	
Drain Current-Continuous(Package Limited)		I_D	781	A
Power Dissipation		P_{tot}	500	W
Avalanche Energy, Single Pulsed ⁽¹⁾		E_{AS}	1796	mJ
Thermal Resistance from Junction to Lead		$R_{\theta JC}$	0.3	°C/W
Thermal Resistance from Junction to Ambient		$R_{\theta JA}$	25	°C/W
Junction and Storage Temperature Range		T_J, T_{STG}	-55~ +175	°C

**4. Electrical Characteristics**

Rating at 25°C ambient temperature unless otherwise specified.

Parameter	Symbol	Test Condition	Min	Typ	Max	Units
Off Characteristics						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	150			V
Zero gate voltage drain current	I_{DSS}	$V_{DS} = 150V, V_{GS} = 0V$			1	μA
Gate-source leakage current	I_{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$			± 100	nA
On characteristics						
Drain-source on-resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 20A$		3.4	4.1	m Ω
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	2.5	3.4	4.5	V
Dynamic Characteristics						
Input capacitance	C_{iss}	$V_{DS} = 75V, V_{GS} = 0V, f = 1MHz$		6235		pF
Output capacitance	C_{oss}			783		pF
Reverse transfer capacitance	C_{rss}			23		pF
Switching Characteristics						
Gate charge total	Q_g	$V_{DS} = 75V, I_D = 20A, V_{GS} = 10V$		91		nC
Gate-Source Charge	Q_{gs}			26		nC
Gate-Drain Charge	Q_{gd}			21		nC
Turn-on delay time	$t_{d(on)}$	$V_{DD} = 75V, V_{GS} = 20V, R_L = 3.3\Omega$		20		nS
Turn-on rise time	t_r			41		nS
Turn-off delay time	$t_{d(off)}$			58		nS
Turn-off fall time	t_f			44		nS
Source-Drain Diode characteristics						
Body Diode Voltage	V_{SD}	$I_{SD} = 40A, V_{GS} = 0V$			1.2	V
Reverse Recovery Time	t_{rr}	$I_F = 40A$		103		ns
Reverse Recovery Charge	Q_{rr}	$dI_F/dt = 500A/\mu s$		431		nC

Note:

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. $V_{DD} = 75V, V_{GS} = 10V, L = 1.0mH$, Starting $T_J = 25^\circ C$
3. The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
4. Essentially independent of operating temperature.



5. Rating And Characteristic Curves

Fig1: Output Characteristics

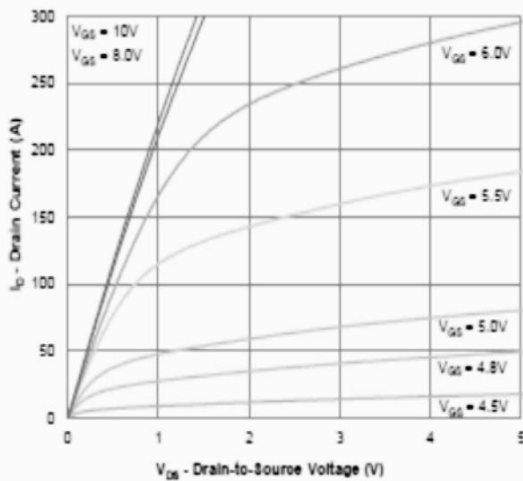


Fig2: Transfer Characteristics

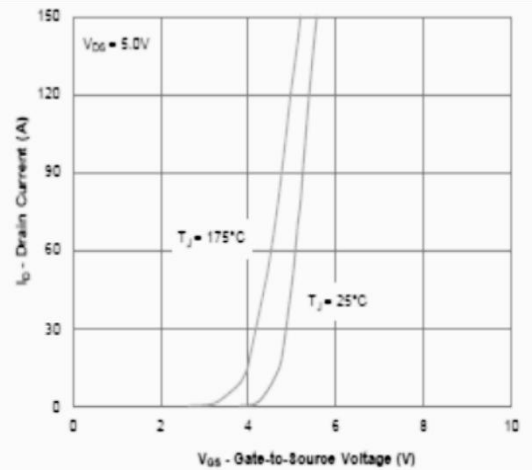


Fig.3 $R_{DS(on)}$ Vs I_D Characteristics ($T_C = 25^\circ\text{C}$)

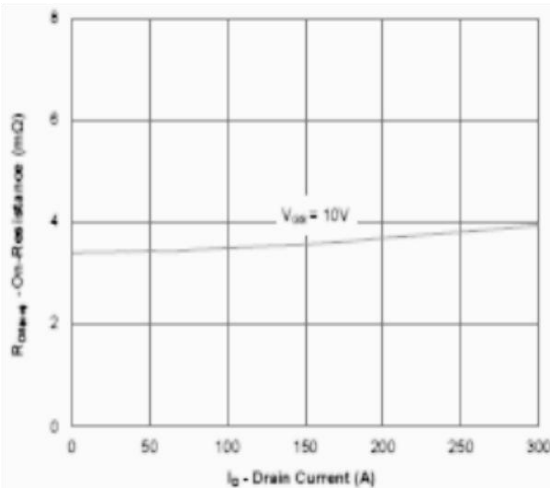


Fig.4 $R_{DS(on)}$ vs Gate Voltage

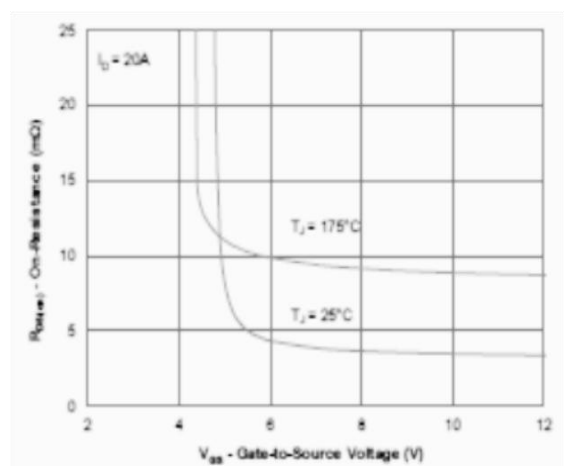


Fig.5 $R_{DS(on)}$ vs. Temperature

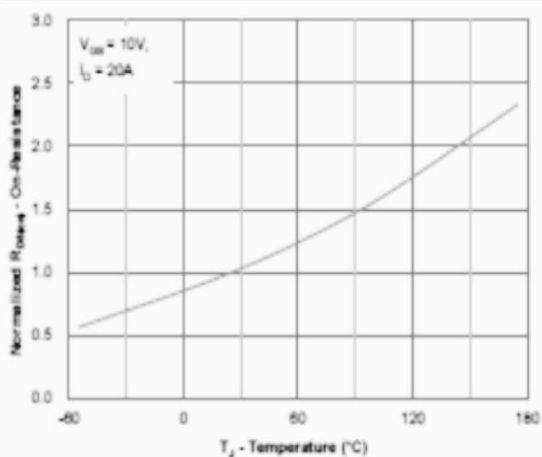


Figure 5: On-Resistance vs. Junction Temperature

Fig.6 Safe Operating Area

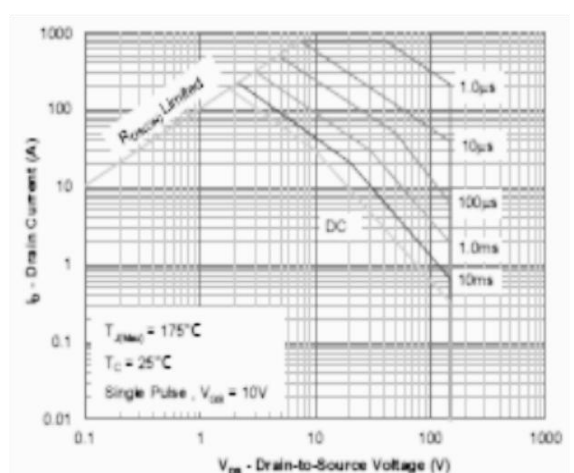




Fig.7 Gate Threshold variation vs. T_J

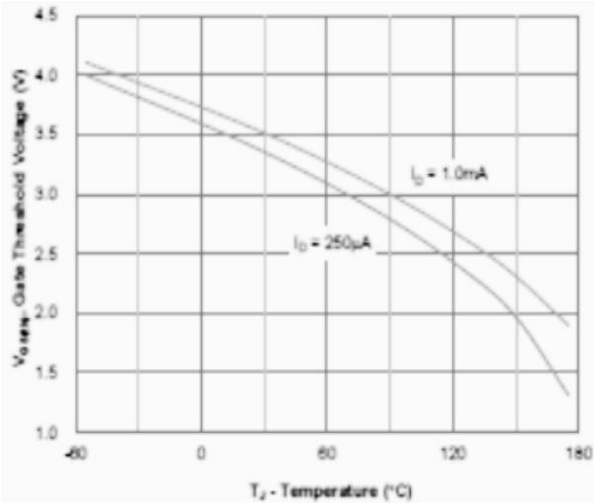


Fig.8 Capacitance Characteristics

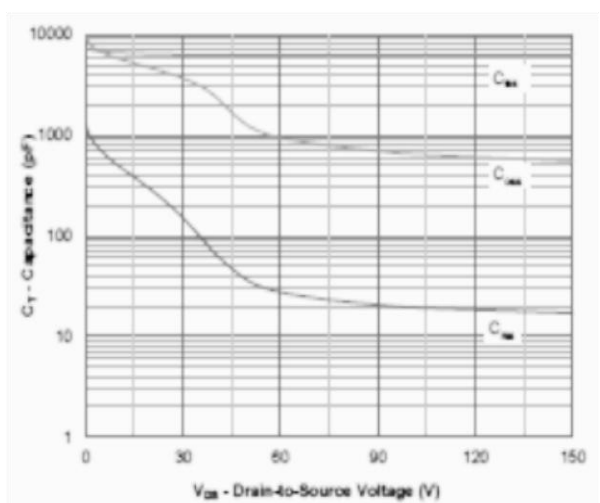


Fig.9 Gate Charge characteristics

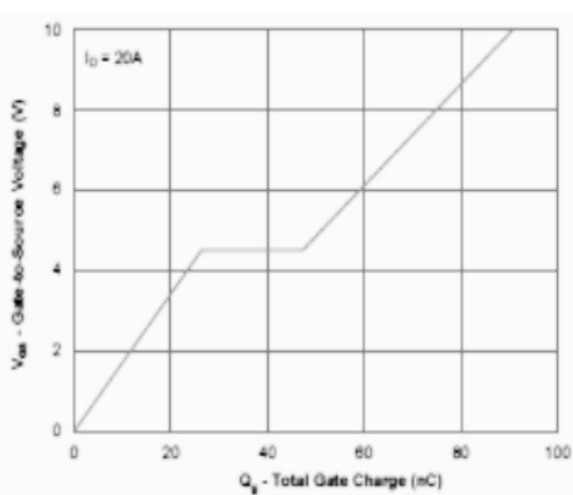


Fig.10 Capaoitance Characteristics

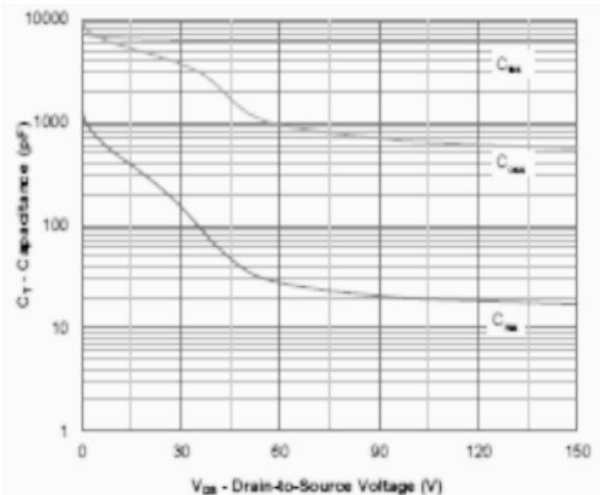


Fig.11 Power Dissipation

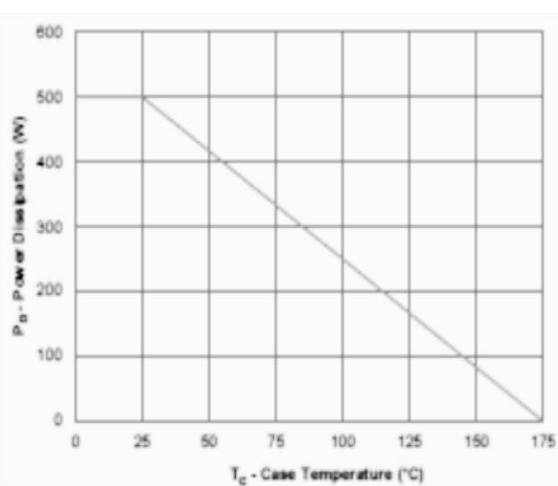


Fig.12 Drain Current Derating

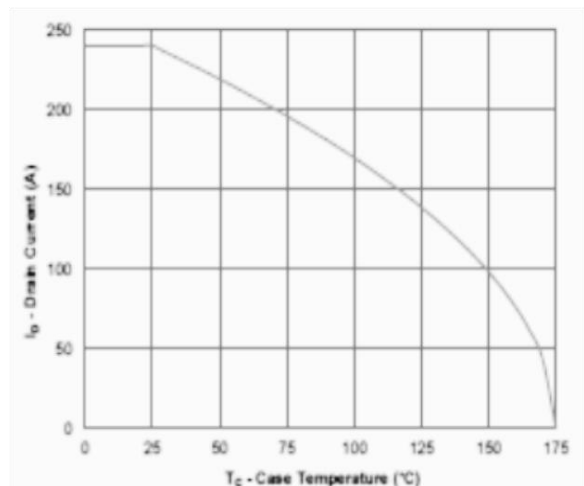
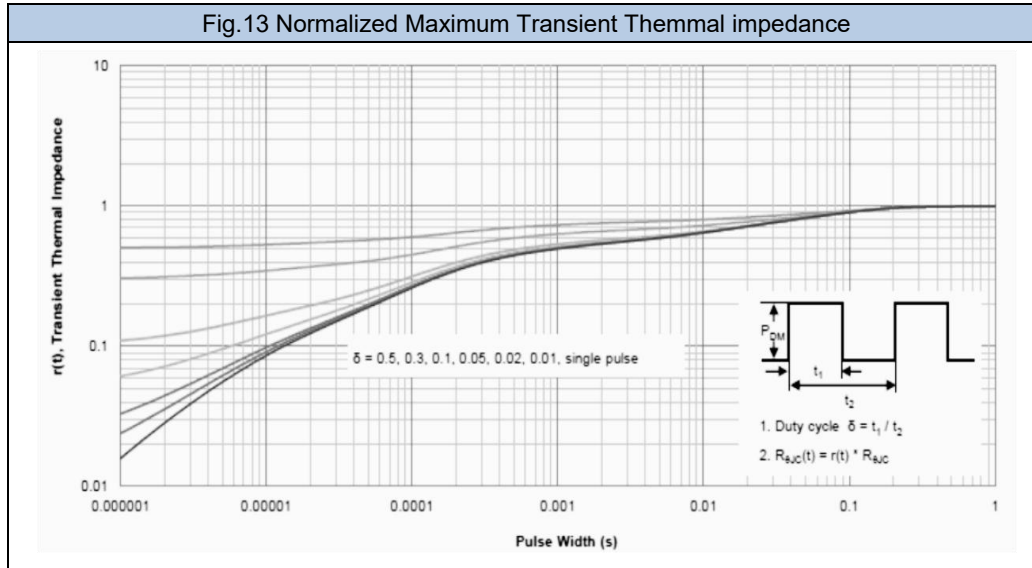


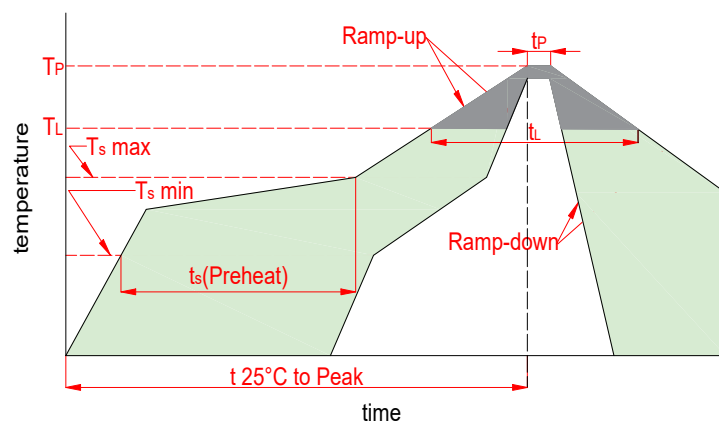


Fig.13 Normalized Maximum Transient Thermal impedance



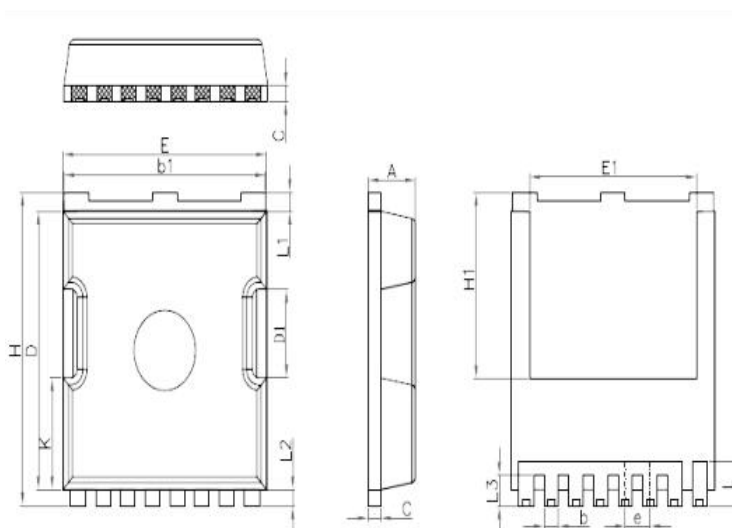


6. Soldering Parameters



Reflow Condition		Lead-free
Pre Heat	Temp. min(T_s (min))	150℃
	Temp. max(T_s (min))	200℃
	Time(min to max)(t_s)	60~180s
Aver. ramp up rate(Liquidus Temp.)(T_L)to peak		3℃/s max
T_s (max) to T_L -Ramp-up Rate		3℃/s max
Reflow	Temp. (T_L)(Liquidus)	217℃
	Temp. (t_L)(Liquidus)	60~150s
Peak Temp. (T_P)		260 ^{+0/-5} ℃
Time within actual peak Temp. (t_p)		30s max
Ramp-down Rate		6℃/s max
Time 25℃ to peak Tempe. (T_P)		8 minutes max
Do not exceed		260℃

7. Dimensions



Dimensions	Inches		Millimeters	
	Min	Max	Min	Max
A	0.087	0.094	2.20	2.40
b	0.024	0.031	0.60	0.80
b1	0.380	0.390	9.65	9.90
C	0.016	0.024	0.40	0.60
D	0.405	0.411	10.28	10.45
D1	0.126	0.134	3.20	3.40
E	0.386	0.394	9.80	10.00
e	0.043	0.051	1.10	1.30
H	0.413	0.465	10.48	11.80
L1	0.024	0.031	0.60	0.80
L2	0.020	0.028	0.50	0.70

8. Package Information

Package	Quantity(pcs)
TOLL	2000



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